

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







**GE** Datasheet

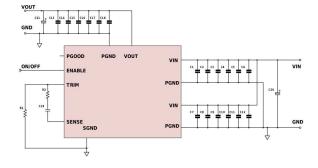
### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)



### **Applications**

- Industrial equipment
- Distributed power architectures
- Telecommunications equipment



#### **Features**

- Compliant to RoHS II EU "Directive 2011/65/EU"
- Compliant to IPC-9592 (September 2008), Category 2, Class II
- Compatible in a Pb-free or SnPb reflow environment (Z versions)
- Compliant to REACH Directive (EC) No 1907/2006
- Wide Input voltage range (8Vdc-16Vdc)
- Output voltage programmable from 32 to 54Vdc via external resistor
- Tunable Loop<sup>™</sup> to optimize dynamic output voltage response
- Power Good signal
- Output over current protection (Vo drops to Vin)
- Over temperature protection
- Remote On/Off
- Support Pre-Biased Output
- Optimized for conduction-cooled applications
- Small size: 27.9 mm x 24 mm x 8.5 mm(MAX)
- Wide operating temperature range [-40°C to 85°C]
- UL\* 60950-1 2<sup>nd</sup> Ed. Recognized, CSA<sup>†</sup> C22.2 No. 60950-1-07 Certified, and VDE<sup>‡</sup> (EN60950-1 2<sup>nd</sup> Ed.) Licensed
- ISO\*\* 9001 and ISO 14001 certified manufacturing facilities

### **Description**

The Boost power modules are non-isolated dc-dc converters that can deliver up to 130W of output power. The module can operate over a wide range of input voltage ( $V_{IN} = 8Vdc-16Vdc$ ) and provide an adjustable 32 to 54VDC output. The output voltage is programmable via an external resistor. Features include remote On/Off, over current and over temperature protection. The module also includes the Tunable Loop<sup>TM</sup> feature that allows the user to optimize the dynamic response of the converter to match the load with reduced amount of output capacitance leading to savings on cost and PWB area.

- \* UL is a registered trademark of Underwriters Laboratories, Inc.
- † CSA is a registered trademark of Canadian Standards Association.
- † VDE is a trademark of Verband Deutscher Elektrotechniker e.V.
  \*\* ISO is a registered trademark of the International Organization of Standards

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Absolute Maximum Ratings**

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage	All	V <sub>IN</sub>	-0.3	18	V
Continuous					
Operating Ambient Temperature	All	TA	-40	85	°C
(see Thermal Considerations section)					
Storage Temperature	All	T <sub>stg</sub>	-55	125	°C

### **General Specifications**

Parameter	Device	Min	Тур	Max	Unit
Calculated MTBF (I <sub>0</sub> =0.8I <sub>0, max</sub> , T <sub>A</sub> =40°C) Telecordia Issue 3 Method 1 Case 3	All		32,263,860		Hours
Weight		_	10.8	_	g (oz.)

### **Electrical Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	All	V <sub>IN</sub>	8	_	16	Vdc
Maximum Input Current (Note 1)	All	I <sub>IN1max</sub>			20	Adc
(V <sub>IN</sub> =8V, Vout = 34V, I <sub>O</sub> =I <sub>O, max</sub> )						
Input No Load Current	V <sub>O,set</sub> = 40 Vdc	I <sub>IN ,No load</sub>			300	mA
$(V_{IN} = 12Vdc, I_0 = 0, module enabled)$	V <sub>O,set</sub> = 54Vdc	I <sub>IN, No load</sub>			350	mA
Input Stand-by Current $(V_{IN} = 12Vdc, module disabled)$	All	IIN ,stand-by		10	20	mA
Inrush Transient	All	l <sub>1</sub> ²t			1	A <sup>2</sup> s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 1µH source impedance; V <sub>IN</sub> =8 to 16V, Io= Iomax; See Test Configurations)	All			285		mAp-p
Input Ripple Rejection (120Hz)	All			15		dB

Note 1 – Both pairs of input power pins (3, 4, 5, and 6) must be used

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

### **Electrical Specifications** (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Voltage Set-point (with 0.1% tolerance for external resistor used to set output voltage)	All	Vo, set		±1%		% VO, set
Output Voltage (Overall operating input voltage, resistive load, and temperature conditions until end of life)	All	Vo, set		±3%		% VO, set
Adjustment Range (selected by an external resistor)	All	Vo	32		54	Vdc
Output Regulation						
Line ( $V_{IN}=V_{IN, min}$ to $V_{IN, mox}$ )	All			0.4		% V <sub>O, set</sub>
Load ( $I_0=I_{0, min}$ to $I_{0, max}$ )	All			0.4		% V <sub>O, set</sub>
Temperature ( $T_{ref}=T_{A,min}$ to $T_{A,max}$ )	All			0.4		% V <sub>O, set</sub>
Input Noise on nominal input at 25°C						
(VIN=VIN, nom and IO=IO, min to IO, max $Cin = 470uF$ )						
Peak-to-Peak (Full Bandwidth) for all Vo	All		_	3%		mVpk-pk
Output Ripple and Noise on nominal output at 25°C						
(V <sub>IN</sub> =V <sub>IN, nom</sub> and I <sub>O</sub> =I <sub>O, min</sub> to I <sub>O, max</sub> Co = $2*470uF$ )						
Peak-to-Peak (Full bandwidth)				300		mV <sub>pk-pk</sub>
RMS (Full bandwidth)	All			180		mV
External Capacitance <sup>1</sup>						
Without the Tunable Loop™						
ESR ≥ 1 mΩ	All	Co, max	22		122	μF
With the Tunable Loop™						
ESR ≥ 0.15 mΩ	All	C <sub>0, max</sub>	47		1000	μF
ESR ≥ 10 mΩ	All	C <sub>0, max</sub>			1000	μF
Output power	All	Po	0		130	Watts
	32Vout				4.06	
Output Current	40Vout				3.25	А
Output Current	48Vout	- I <sub>o</sub>			2.71	A
	54Vout				2.41	
Output Current Limit Inception (Hiccup Mode) (current limit does not operate in sink mode) 2	All	I <sub>O, lim</sub>		150		% I <sub>o,max</sub>
Efficiency	V <sub>O</sub> , = 40Vdc	η		93.0		%
V <sub>IN</sub> = 12Vdc, T <sub>A</sub> =25°C	V <sub>0</sub> , = 48Vdc	η		92.0		%
$I_O=I_{O, max}$ , $V_O=V_{O, set}$	V <sub>0</sub> ,= 54Vdc	η		91.0		%
Switching Frequency	All	$f_{sw}$	_	322	_	kHz

<sup>&</sup>lt;sup>1</sup> External capacitors may require using the new Tunable Loop™ feature to ensure that the module is stable as well as getting the best transient response. See the Tunable Loop™ section for details.

<sup>2.</sup> Because of the inherent body diode of the high-side MOSFET in Synchronous Boost Converter, this Boost PoL do not support short circuit protection. When OCP, VOUT will be drop down to a voltage close to Vin (Not 0V), so the total output power will be reduced.

# 130W Boost Converter: Non-Isolated DC-DC Power Modules 8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

### **Feature Specifications**

Parameter	Device	Symbol	Min	Тур	Max	Unit
On/Off Signal Interface						
$(V_{IN}=V_{IN,min}$ to $V_{IN,max}$ ; open collector or equivalent,						
Signal referenced to GND)						
Device Code with no suffix – Negative Logic (See Ordering Information)						
(On/OFF pin is open collector/drain logic input with						
external pull-up resistor; signal referenced to GND)						
Logic High (Module OFF)						
Input High Current	All	Іін	_	_	1	mA
Input High Voltage	All	VIH	2.5	_	V <sub>IN, max</sub>	Vdc
Logic Low (Module ON)						
Input low Current	All	lıL	_	_	1	mA
Input Low Voltage	All	VIL	-0.2	_	0.6	Vdc
Turn-On Delay and Rise Times						
( $V_{IN}=V_{IN, nom, lo}=I_{O, max}$ , $V_{O}$ to within $\pm 1\%$ of steady state)						
Case 1: On/Off input is enabled and then input power is applied (delay from instant at which $V_{IN} = V_{IN,min}$ until $V_0 = 10\%$ of ( $V_0$ , set - $V_{IN}$ )	All	Tdelay1	_	24	_	msec
Case 2: Input power is applied for at least one second and then the On/Off input is enabled (delay from instant at which Von/Off is enabled until Vo = 10% of (Vo, set - Vin))	All	Tdelay1	_	24	-	msec
Output voltage Rise time (time for Vo to rise from 10% of (Vo, set - Vin), set to 90% of (Vo, set - Vin))	All	Trise1		32	-	msec
Output voltage overshoot ( $T_A = 25$ °C $V_{IN} = V_{IN, min}$ to $V_{IN, max, Io} = I_{O, min}$ to $I_{O, max}$ ) With or without maximum external capacitance				3		% V <sub>O, set</sub>

# 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

### **Feature Specifications (cont.)**

Parameter	Device	Symbol	Min	Тур	Max	Units
Over Temperature Protection (See Thermal Considerations section)	All	$T_{ref}$		135		°C
Input Undervoltage Lockout *						
Turn-on Threshold	All				7.7	Vdc
Turn-off Threshold	All		6.0			Vdc
Hysteresis	All			1		Vdc
PGOOD (Power Good)						
Signal Interface Open Drain, V <sub>supply</sub> ≤ 5VDC						
Overvoltage threshold for PGOOD ON	All			107.6		%V <sub>O</sub> , set
Overvoltage threshold for PGOOD OFF	All			112.8		%V <sub>O,</sub>
Undervoltage threshold for PGOOD ON	All			92.2		%V <sub>O</sub> ,
Undervoltage threshold for PGOOD OFF	All			87.9		%V <sub>O</sub> ,
Pulldown resistance of PGOOD pin	All			94		Ω
Sink current capability into PGOOD pin	All		6			mA

<sup>\*</sup>For Vin >32V, there is a minimum Vin at different Vout, Input UVLO doesn't apply

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Characteristic Curves**

The following figures provide typical characteristics for the ABXS003at 32Vo and 25°C.

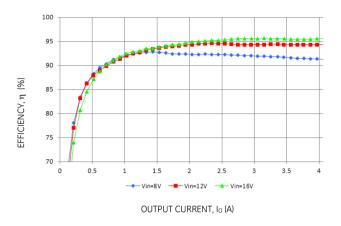


Figure 1. Converter Efficiency versus Output Current.

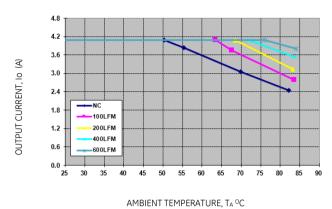
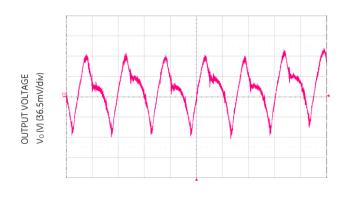


Figure 2. Derating Output Current versus Ambient Temperature and Airflow., VIN=12V



TIME, t (2us/div)

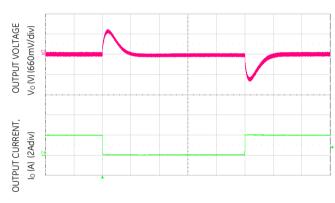
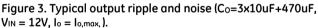


Figure 4. Transient Response to Dynamic Load Change from 50% to 0% at 12Vin, Cout=3x10uF+470uF, CTune=1000pF,

TIME, t (2ms /div)



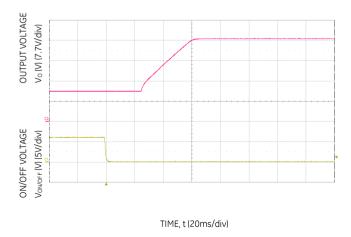


Figure 5. Typical Start-up Using On/Off Voltage ( $I_0 = I_{0,max}$ ).

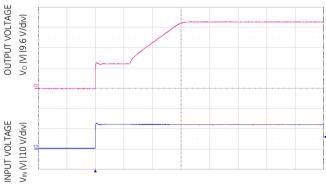


Figure 6. Typical Start-up Using Input Voltage ( $V_{IN} = 12V$ ,  $I_0 = I_{0,max}$ ).

TIME, t (20ms/div)

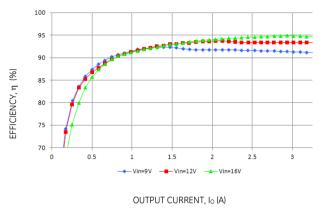
RTune=30.1k $\Omega$ 

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Characteristic Curves**

The following figures provide typical characteristics for the ABXS003 at 40Vo and 25°C.

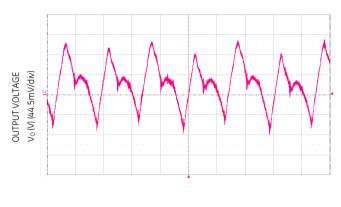


3.0
2.4
1.8
1.2
1.00LFM
200LFM
400LFM
400LFM
0.0
25 30 35 40 45 50 55 60 65 70 75 80 85 9

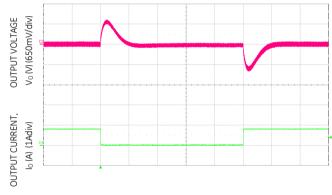
AMBIENT TEMPERATURE, TA °C

Figure 7. Converter Efficiency versus Output Current.

Figure 8. Derating Output Current versus Ambient Temperature and Airflow., VIN=12V



TIME, t (2us/div)



TIME, t (1ms /div)

Figure 10. Transient Response to Dynamic Load Change from

50% to 0% at 12Vin, Cout=3x10uF+470uF, CTune=1000pF,

Figure 9. Typical output ripple and noise ( $C_0=3x10uF+470uF$ ,  $V_{IN}=12V$ ,  $I_0=I_{0,max}$ ,).

ON/OFF VOLTAGE
ON/OFF VOLTAGE
OUTPUT VOLTAGE
VoworF (VI (5V/div))
Vo (V) (9.6V/div)

TIWE' t (50ws/qiv)

Figure 11. Typical Start-up Using On/Off Voltage (Io = Io,max).

INPUT VOLTAGE OUTPUT VOLTAGE

V<sub>IN</sub> (V) (10V/div) V<sub>O</sub> (V) (12V/div)

TIME, t (20ms/div)

Figure 12. Typical Start-up Using Input Voltage ( $V_{IN} = 12V$ ,  $I_0 = I_{0,max}$ ).

RTune=30.1k $\Omega$ 

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Characteristic Curves**

The following figures provide typical characteristics for the ABXS003 at 48Vo and 25°C.

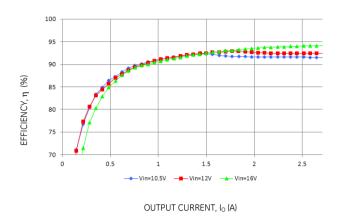


Figure 13. Converter Efficiency versus Output Current.

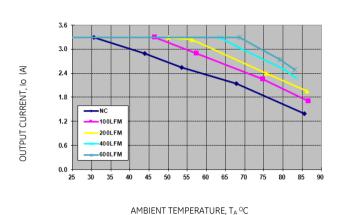


Figure 14. Derating Output Current versus Ambient Temperature and Airflow. VIN = 12V

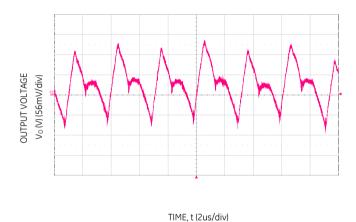


Figure 15. Typical output ripple and noise( $C_0=3x10uF+470uF$ ,  $V_{IN}=12V$ ,  $I_0=I_{0,max}$ ,).

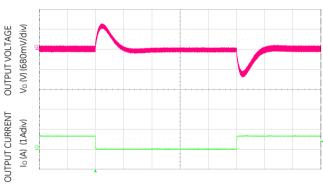


Figure 16. Transient Response to Dynamic Load Change from 50% to 0% at 12Vin, Cout=470uF, CTune=1000pF, RTune=30.1k $\Omega$ 

TIME, t (1ms /div)

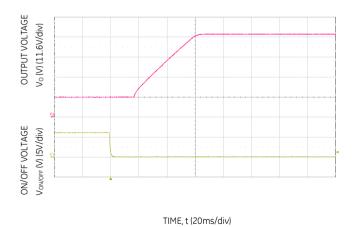


Figure 17. Typical Start-up Using On/Off Voltage (Io = Io,max).

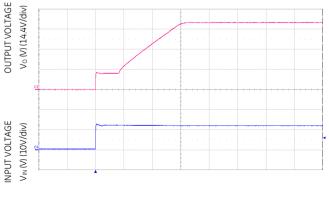


Figure 18. Typical Start-up Using Input Voltage ( $V_{IN}=12V$ ,  $I_{o}=I_{o,max}$ ).

TIME, t (20ms/div)

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Characteristic Curves**

The following figures provide typical characteristics for the ABXS003 at 54Vo and 25°C

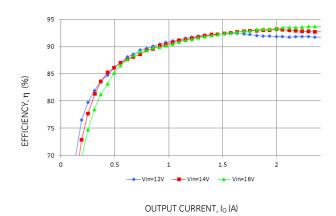


Figure 19. Converter Efficiency versus Output Current.

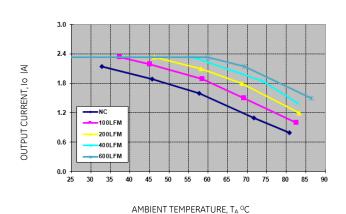


Figure 20. Derating Output Current versus Ambient Temperature and Airflow. VIN = 14V

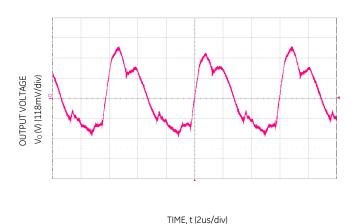


Figure 21. Typical output ripple and noise(C<sub>0</sub>=3x10uF+470uF,



TIME, t (1ms /div)

Figure 22. Transient Response to Dynamic Load Change from 50% to 0% at 12Vin, Cout=470uF, CTune=1000pF, RTune=30.1k $\Omega$ 

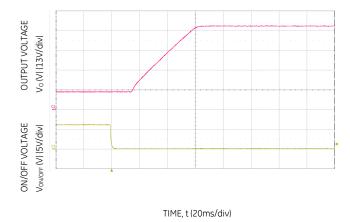
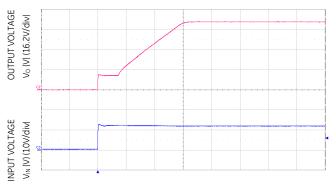


Figure 23. Typical Start-up Using On/Off Voltage ( $I_0 = I_{o,max}$ ).



TIME, t (20ms/div)

Figure 24. Typical Start-up Using Input Voltage (VIN = 12V, Io =  $I_{0,max}$ ).

 $V_{IN} = 12V$ ,  $I_0 = I_{0,max}$ ,).

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Input Filtering**

The ABXS003 Open Frame module should be connected to a low ac-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, ceramic capacitors are recommended at the input of the module.

Both pairs of input power pins (3, 4, 5, and 6) must be used.

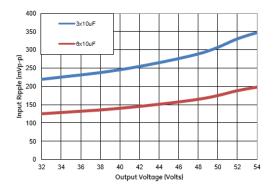


Figure 25. Input ripple voltage. Input voltage is 12V. Scope BW Limited to 20MHz

#### **Output Filtering**

These modules are designed for low output ripple voltage and will meet the maximum output ripple specification with 66uF ceramic capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. Figure 26 provides output ripple information, measured with a scope with its Bandwidth limited to 20MHz for different external capacitance values at various Vo. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table. Optimal performance of the module can be achieved by using the Tunable Loop $^{\text{TM}}$  feature described later in this data sheet.

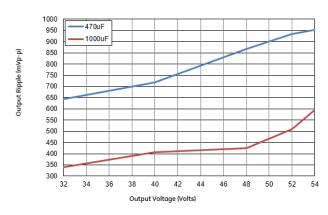


Figure 26. Output ripple voltage .Input voltage is 12V. Scope BW Limited to 20MHz

#### **Safety Considerations**

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a 25A Fuse in the positive input lead.

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Analog Feature Descriptions**

#### Remote On/Off

The ABXS003 Open Frame power modules feature an On/Off pin for remote On/Off operation.

For negative logic On/Off modules, the circuit configuration is shown in Fig. 27. The On/Off pin should be pulled high with an external pull-up resistor. When Q1 turns On, the On/OFF pin is pulled low. This turns Q2 off and the internal PWM Enable is pulled high and the module turns on. When Q1 is Off, Q2 turns ON and the internal PWM Enable is pulled low and the module turns OFF

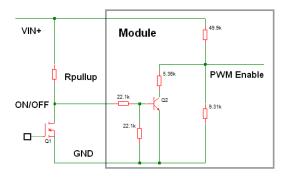


Figure 27. Circuit configuration for using negative On/Off logic.

#### **Monotonic Start-up and Shutdown**

The module has monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.

#### **Startup into Pre-biased Output**

The module can start into a prebiased output as long as the prebias voltage is 5V less than the set output voltage.

#### **Analog Output Voltage Programming**

The output voltage of each output of the module can be programmable to any voltage from 16VDC to 34VDC by connecting a resistor between the Trims and GND pins of the module.

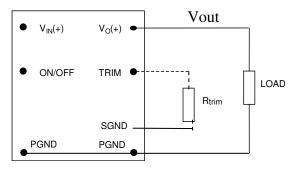


Figure 28. Circuit configuration for programming output voltage using an external resistor.

Without an external resistor between TRIM and sGND pins, each output of the module will be the same as input voltage. The value of the trim resistor, *Rtrim* for a desired output voltage, should be as per the following equation:

$$Rtrim = \left[\frac{1.2}{(Vo - 1.2)}\right] \times 200.5K\Omega$$

Rtrim is the external resistor in  $k\Omega$  Vo is the desired output voltage.

Table 1 Trim Resistor (1% resolution or better)

Vo,set (V)	Rtrim (k <b>Ω</b> )
32	7.812
40	6.201
48	5.141
54	4.557

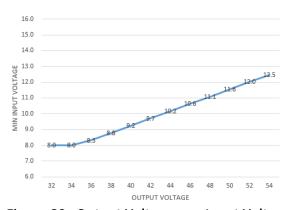


Figure 29. Output Voltages vs. Input Voltage Set point Area plot showing limits where the output voltage can be set for different input voltages

#### **Analog Voltage Margining**

Output voltage margining can be implemented in the module by connecting a resistor, R<sub>margin-up</sub>, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, R<sub>margin-down</sub>, from the Trim pin to output pin for margining-down. Figure 30 shows the circuit configuration for output voltage margining. The POL Programming Tool, available at www.gecriticalpower.com under the Downloads section, also calculates the values of R<sub>margin-up</sub> and R<sub>margin-down</sub> for a specific output voltage and % margin. Please consult your local GE Critical Power technical representative for additional details

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

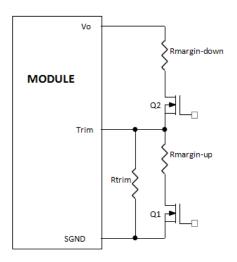


Figure 30. Circuit Configuration for margining Output voltage.

#### **Overcurrent Protection**

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range.

#### **Overtemperature Protection**

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shut down if the overtemperature threshold of 129°C(typ) is exceeded at the thermal reference point  $T_{\text{ref.}}$ 

Once the unit goes into thermal shutdown it will then wait to cool before attempting to restart.

#### **Input Undervoltage Lockout**

At input voltages below the input undervoltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

#### Tunable Loop™

The module has a feature that optimizes transient response of the module called Tunable Loop<sup>TM</sup>.

External capacitors are usually added to the output of the module for two reasons: to reduce output ripple and noise (see Figure 26) and to reduce output voltage deviations from the steady-state value in the presence of dynamic load current changes. Adding external capacitance however

affects the voltage control loop of the module, typically causing the loop to slow down with sluggish response. Larger values of external capacitance could also cause the module to become unstable.

The Tunable  $\mathsf{Loop}^\mathsf{TM}$  allows the user to externally adjust the voltage control loop to match the filter network connected to the output of the module. The Tunable  $\mathsf{Loop}^\mathsf{TM}$  is implemented by connecting a series R-C between the VOUT and TRIM pins of the module, as shown in Fig. 31. This R-C allows the user to externally adjust the voltage loop feedback compensation of the module.

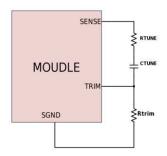


Figure. 31. Circuit diagram showing connection of  $R_{\text{TUME}}$  and  $C_{\text{TUNE}}$  to tune the control loop of the module

Please contact your GE Critical Power technical representative to obtain more details of this feature as well as for guidelines on how to select the right value of external R-C to tune the module for best transient performance and stable operation for other output capacitance values.

Table 2. General recommended values of of  $R_{\text{TUNE}}$  and  $C_{\text{TUNE}}$  for Vin=12V and various external ceramic capacitor combinations. Vo=40V

Со	200μF	300μF	400μF	500μF	600μF
RTUNE	274k	274k	274k	200k	200k
C <sub>TUNE</sub>	470p	470p	470p	470p	1000p

### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

Table 3. Recommended values of  $R_{\text{TUNE}}$  and  $C_{\text{TUNE}}$  to obtain transient deviation of 2% of Vout for a 50% full load step load with Vin=12V

Vin		12	2V	
Vo	32V	40V	48V	54V
ΔΙ	2A	1.6A	1.35A	1.2A
Со	9×10uF + 1×680μF	9×10uF + 1×680μF	9×10μF+ 1×680μF	9×10μF+ 1×680μF
RTUNE	200k <b>Ω</b>	200k <b>Ω</b>	200k <b>Ω</b>	274k <b>Ω</b>
C <sub>TUNE</sub>	470pF	470pF	470pF	470pF
ΔV	256mV	432mV	566mV	769mV

#### **Power Good**

The module provides a Power Good (PGOOD) signal that is implemented with an open-drain output to indicate that the output voltage is within the regulation limits of the power module.

The PGOOD signal will be de-asserted to a low state if any condition such as overtemperature, overcurrent or loss of regulation occurs that would result in the output voltage going outside the specified thresholds.

The PGOOD terminal can be connected through a pullup resistor (suggested value  $10k\Omega$ ) to a source of 5VDC or lower.

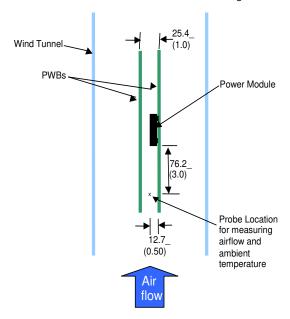
### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Thermal Considerations**

Power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test set-up is shown in Figure 32. The preferred airflow direction for the module is in Figure 33.





The thermal reference points,  $T_{\text{ref}}$  used in the specifications are also shown in Figure 33. For reliable operation the temperatures at the Q1 should not exceed 135°C. The output power of the module should not exceed the rated power of the module (Vo,set x Io,max).

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

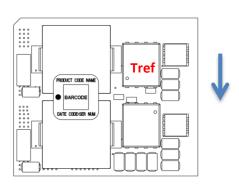


Figure 32. Preferred airflow direction and location of hot-spot of the module (Tref).

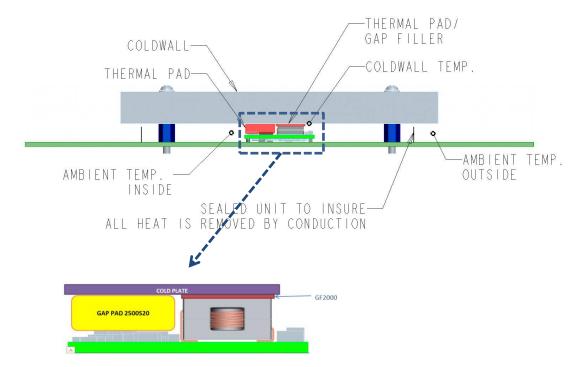
### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Heat Transfer via Conduction**

The module can also be used in a sealed environment with cooling via conduction from the module's top surface through a gap pad material to a coldwall, as shown below.

Thermal pad: Bergquist P/N: GP2500S20 Gap filler: Bergquist P/N: GF2000



### 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

### **Example Application Circuit**

#### **Requirements:**

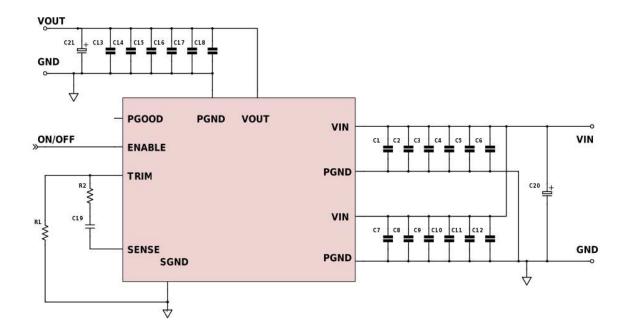
Vin: 12V (Note: Two VIN-PGND ports must all connected to external power source)

Vout: 48V

lout: 2.7A max., worst case load transient is from 2.2A to 3.4A

ΔVout: 1.5% of Vout (420mV) for worst case load transient

Vin, ripple 1.5% of Vin (180mV, p-p)



C2-C6, C8-C12 4.7µF/25V, 1210 ceramic capacitor

C1,C7 0.047uF/50V,0603 ceramic capacitor

C20 470uF/25V, bulk electrolytic

C13-C17 4.7 $\mu$ F/50V, 1210 ceramic capacitor

C18 0.01uF/100V,0805 ceramic capacitor

C21 470uF/100V, bulk electrolytic

R1 5.11k **Ω** 

C19 (CTune) 1000pF ceramic capacitor (can be 1206, 0805 or 0603 size)

R2(RTune) 30.1k  $\Omega$  SMT resistor (can be 1206, 0805 or 0603 size)

# 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Mechanical Outline**

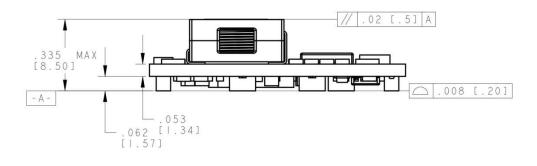
Dimensions are in millimeters and (inches).

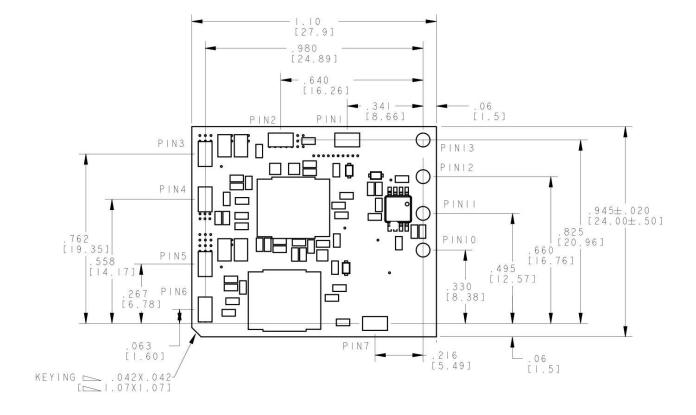
#### **Tolerances:**

x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.)

x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)

[unless otherwise indicated]





# 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

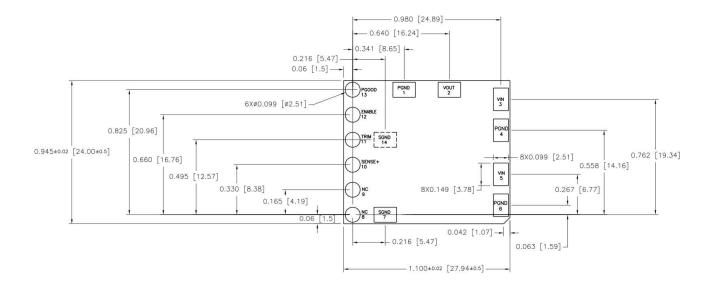
#### **Recommended Pad Layout**

Dimensions are in millimeters and (inches).

Tolerances:

x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [unless otherwise indicated]

 $x.xx mm \pm 0.25 mm (x.xxx in \pm 0.010 in.)$ 



PIN	FUNCTION	PIN	FUNCTION
1	PGND	8	NC
2	VOUT	9	NC
3	VIN	10	SENSE+
4	PGND	11	TRIM
5	VIN	12	ENABLE
6	PGND	13	PGOOD
7	SGND	14*	SGND

<sup>\*</sup>PIN 14 is an optional pad, only need if you want this footprint can also cover the 65W Boost PoL (ABXS001/002)

Both pairs of input power pins (3, 4, 5, and 6) must be used

# 130W Boost Converter: Non-Isolated DC-DC Power Modules

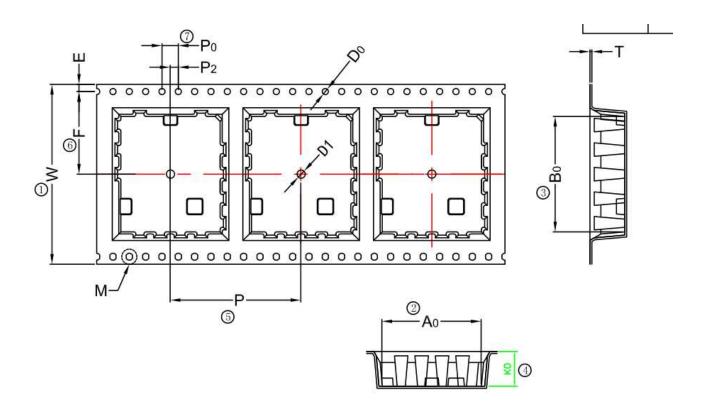
8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

### **Packaging Details**

The ABXS003 Open Frame modules are supplied in tape & reel as standard.

Modules are shipped in quantities of 150 modules per reel.

All Dimensions are in millimeters.



ITEM	W	AO	ВО	КО	K1	P	F	Е	S0	D0	D1	P0	P2	Т
DIM	+0.30 44.00-0.30	24.3 <sup>+0.10</sup> -0.10	28.24 <sup>+0.10</sup>	8.5+ <sup>0.10</sup>		32.00+ <sup>0.10</sup> <sub>-0.10</sub>	20.2+0.10	1.75+ <sup>0.10</sup>		+0.10 1.5-0.00	2.00 <sup>+0.10</sup>	4.00+ <sup>0.10</sup> <sub>-0.10</sub>	2.00+0.10	+0.05 0.4-0.05

# 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Surface Mount Information**

#### Pick and Place

The ABXS003 Open Frame modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and place operations. The label meets all the requirements for surface mount processing, as well as safety standards, and is able to withstand reflow temperatures of up to 300°C. The label also carries product information such as product code, serial number and the location of manufacture

#### Stencil and Nozzle Recommendations

Stencil thickness of 6 mils minimum must be used for this product. The module weight has been kept to a minimum by using open frame construction. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process. The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

#### **Lead Free Soldering**

The modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

#### **Pb-free Reflow Profile**

Power Systems will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Fig. 35. Soldering outside of the recommended profile requires testing to verify results and performance.

#### **MSL Rating**

The ABXS003 Open Frame modules have a MSL rating of 2a

#### Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not

be broken until time of use. Once the original package is broken, the floor life of the product at conditions of  $\leq$  30°C and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: < 40° C, < 90% relative humidity.

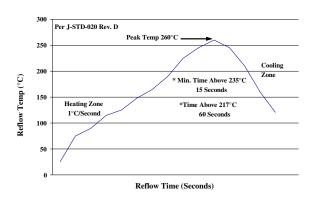


Figure 35. Recommended linear reflow profile using Sn/Ag/Cu solder.

#### **Post Solder Cleaning and Drying Considerations**

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to *Board Mounted Power Modules*: *Soldering and Cleaning* Application Note (AN04-001).

# 130W Boost Converter: Non-Isolated DC-DC Power Modules

8Vdc -16Vdc input; 32Vdc - 54Vdc output, 130W output power (max.)

#### **Ordering Information**

Please contact your GE Sales Representative for pricing, availability and optional features.

#### **Table 4. Device Codes**

Device Code	Input Voltage Range	Output Voltage	Output Current	On/Off Logic	Comcodes
ABXS003A3X341-SRZ	8 – 16Vdc	32 – 54Vdc	3.3A (40V)	Negative	1600096705A

<sup>-</sup>Z refers to RoHS compliant parts

#### Table 5. Coding Scheme

Package Identifier		Sequencing Option	Input Voltage Range	Output current	Output voltage	On/Off logic	Remote Sense	Special Code	Options	ROHS Compliance
Α	В	X	S	003A3	X		3	41	-SR	Z
A=Non- Isolated, Non-4G	B=Boost POL	X=without sequencing	8-16Vdc	3.3A	X = programm able output	4 = positive No entry = negative	3 = Remote Sense	24/48V Output	S = Surface Mount R = Tape & Reel	Z = ROHS6

### Contact Us

For more information, call us at

USA/Canada:

**+1 888 546 3243**, or +1 972 244 9288

Asia-Pacific:

+86.021.54279977\*808

Europe, Middle-East and Africa:

+49.89.878067-280

www.gecriticalpower.com

GE Critical Power reserves the right to make changes to the product(s) or information contained herein without notice, and no liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information.

